30 V, 100 mA NPN general-purpose transistors Rev. 07 — 17 November 2009

Product data sheet

Product profile 1.

1.1 General description

NPN general-purpose transistors in Surface Mounted Device (SMD) plastic packages.

Table 1. **Product overview**

Type number	Package	PNP		
	Nexperia	JEITA	JEDEC	complement
BC848B	SOT23	-	TO-236AB	BC858B
BC848W	SOT323	SC-70	-	BC858W

1.2 Features

- General-purpose transistors
- SMD plastic packages

1.3 Applications

General-purpose switching and amplification

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	30	V
I _C	collector current		-	-	100	mA
h _{FE}	DC current gain	$V_{CE} = 5 V;$ $I_{C} = 2 mA$				
	BC848B		200	290	450	
	BC848W		110	-	800	



2. Pinning information

Table 3.	Pinning		
Pin	Description	Simplified outline Symbol	
1	base	_	
2	emitter	3	3
3	collector	1 1 2 006aaa144 sym0	2

3. Ordering information

Table 4. Orde	ring inform	ation	
Type number	Package		
	Name	Description	Version
BC848B	-	plastic surface mounted package; 3 leads	SOT23
BC848W	SC-70	plastic surface mounted package; 3 leads	SOT323

4. Marking

Table 5. Marking codes	
Type number	Marking code ^[1]
BC848B	1K*
BC848W	1M*

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

5. Limiting values

Table 6. In accorda	Limiting values nce with the Absolute Maximu	ım Rating System (I	EC 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	30	V
V _{CEO}	collector-emitter voltage	open base	-	30	V
V _{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \leq 1 \text{ ms}$	-	200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u>		
	SOT23		-	250	mW
	SOT323		-	200	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Parameter	Conditions	Min	Тур	Max	Unit
thermal resistance from junction to ambient	in free air	<u>[1]</u>			
SOT23		-	-	500	K/W
SOT323		-	-	625	K/W
	thermal resistance from junction to ambient SOT23	thermal resistance from in free air junction to ambient SOT23	thermal resistance from in free air [1] junction to ambient SOT23 -	thermal resistance from in free air [1] junction to ambient SOT23	thermal resistance from in free air junction to ambient SOT23 500

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

Product data sheet

7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$		-	-	15	nA
	current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$		-	-	5	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
h _{FE}	DC current gain	V_{CE} = 5 V; I_C = 10 μ A		-	150	-	
		$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$					
		BC848B		200	290	450	
		BC848W		110	-	800	
OLGUI	collector-emitter saturation voltage	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$		-	90	250	mV
		$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	[1]	-	200	600	mV
V _{BEsat}	base-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	[2]	-	700	-	mV
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	[2]	-	900	-	mV
V _{BE}	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	[3]	580	660	700	mV
		$I_{C} = 10 \text{ mA}; V_{CE} = 5 \text{ V}$	[3]	-	-	770	mV
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz		100	-	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz		-	2.5	3	pF
NF	noise figure	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 200 \mu\text{A};$ $R_{S} = 2 k\Omega; f = 1 k\text{Hz};$ B = 200 Hz		-	2	10	dB

 Table 8.
 Characteristics

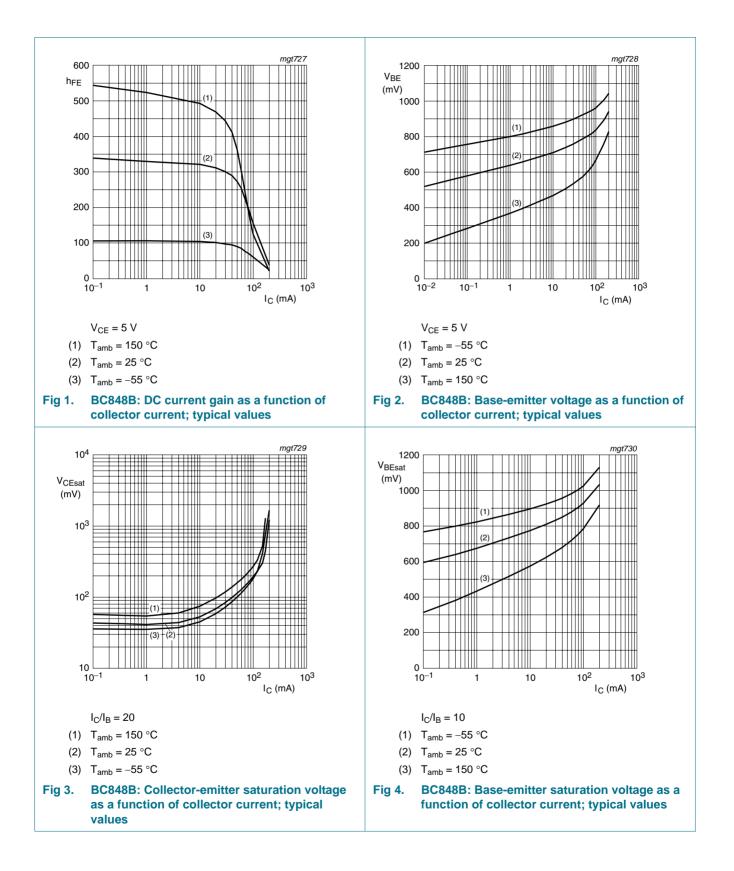
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[2] V_{BEsat} decreases by approximately 1.7 mV/K with increasing temperature.

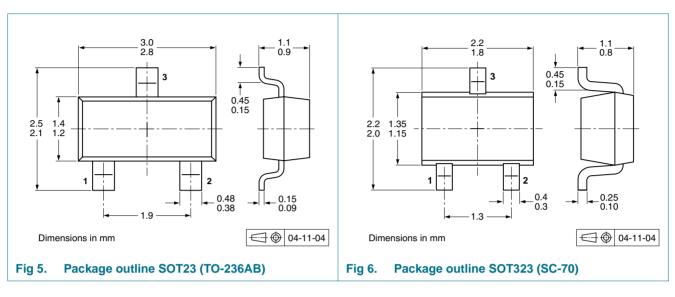
[3] V_{BE} decreases by approximately 2 mV/K with increasing temperature.

30 V, 100 mA NPN general-purpose transistors



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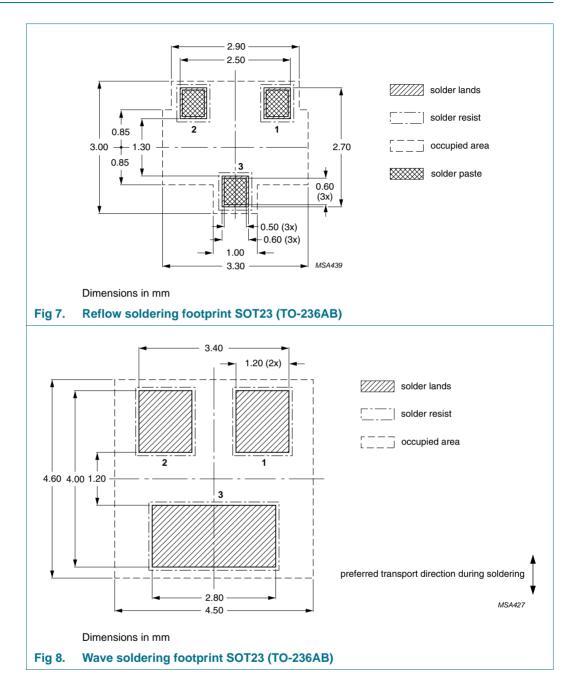
8. Package outline



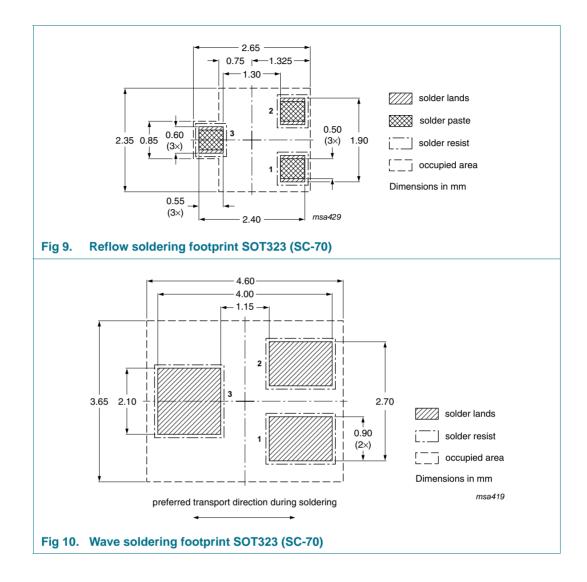
9. Packing information

Please refer to packing information on <u>www.nexperia.com</u>.

10. Soldering

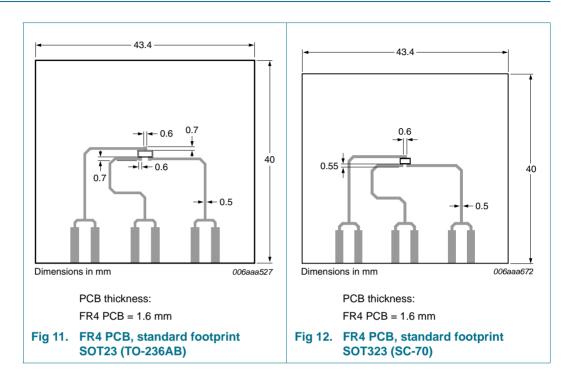


30 V, 100 mA NPN general-purpose transistors



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11. Mounting



12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BC848_SER_7	20091117	Product data sheet	-	BC848_SER_6
Modifications:		et was changed to reflect th legal definitions and discla		
	Figure 9 "Refle	ow soldering footprint SOT	323 (SC-70)": updated	d
	Figure 10 "Wa	ve soldering footprint SOT	<u>323 (SC-70)"</u> : update	d
BC848_SER_6	20060203	Product data sheet	-	BC846_BC847_ BC848_5 BC846W_BC847W_ BC848W_4
BC846_BC847_BC848_5	20040206	Product specification	-	BC846_BC847_ BC848_4
BC846W_BC847W_ BC848W_4	20020204	Product specification	-	BC846W_847W_3

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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14. Contents

1	Product profile 1
1.1	General description 1
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 3
7	Characteristics 4
8	Package outline 6
9	Packing information 6
10	Soldering 7
11	Mounting
12	Revision history 10
13	Legal information 11
13.1	Data sheet status 11
13.2	Definitions 11
13.3	Disclaimers
13.4	Trademarks 11
14	Contents 12

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